# onsemi

## **Hex Buffer**

## MC14049B, MC14050B

The MC14049B Hex Inverter/Buffer and MC14050B Noninverting Hex Buffer are constructed with MOS P–Channel and N–Channel enhancement mode devices in a single monolithic structure. These complementary MOS devices find primary use where low power dissipation and/or high noise immunity is desired. These devices provide logic level conversion using only one supply voltage, V<sub>DD</sub>.

The input-signal high level (V<sub>IH</sub>) can exceed the V<sub>DD</sub> supply voltage for logic level conversions. Two TTL/DTL loads can be driven when the devices are used as a CMOS-to-TTL/DTL converter (V<sub>DD</sub> = 5.0 V, V<sub>OL</sub>  $\leq$  0.4 V, I<sub>OL</sub>  $\geq$  3.2 mA).

Note that pins 13 and 16 are not connected internally on these devices; consequently connections to these terminals will not affect circuit operation.

#### Features

- High Source and Sink Currents
- High-to-Low Level Converter
- Supply Voltage Range = 3.0 V to 18 V
- V<sub>IN</sub> can exceed V<sub>DD</sub>
- Meets JEDEC B Specifications
- Improved ESD Protection On All Inputs
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### MAXIMUM RATINGS (Voltages Referenced to V<sub>SS</sub>)

Symbol	Parameter	Value	Unit
V <sub>DD</sub>	DC Supply Voltage Range	-0.5 to +18.0	V
V <sub>in</sub>	Input Voltage Range (DC or Transient)	-0.5 to +18.0	V
V <sub>out</sub>	Output Voltage Range (DC or Transient)	-0.5 to V <sub>DD</sub> + 0.5	V
l <sub>in</sub>	Input Current (DC or Transient) per Pin	±10	mA
l <sub>out</sub>	Output Current (DC or Transient) per Pin	±45	mA
PD	Power Dissipation, per Package (Note 1) (Plastic) (SOIC)	825 740	mW
T <sub>A</sub>	Ambient Temperature Range	-55 to +125	°C
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	°C
TL	Lead Temperature (8-Second Soldering)	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: See Figure 3.

This device contains protection circuitry to protect the inputs against damage due to high static voltages or electric fields referenced to the V<sub>SS</sub> pin only. Extra precautions must be taken to avoid applications of any voltage higher than the maximum rated voltages to this high–impedance circuit. For proper operation, the ranges V<sub>SS</sub>  $\leq$  V<sub>in</sub>  $\leq$  18 V and V<sub>SS</sub>  $\leq$  V<sub>out</sub>  $\leq$  V<sub>DD</sub> are recommended.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either  $V_{SS}$  or  $V_{DD}$ ). Unused outputs must be left open.





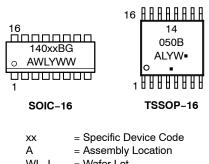
SOIC-16 D SUFFIX CASE 751B

TSSOP-16 DT SUFFIX CASE 948F

#### PIN ASSIGNMENT

V <sub>DD</sub> [	1●	16	] NC
OUT <sub>A</sub> [	2	15	] OUT <sub>F</sub>
IN <sub>A</sub> [	3	14	] IN <sub>F</sub>
OUT <sub>B</sub> [	4	13	] NC
IN <sub>B</sub> [	5	12	] OUT <sub>E</sub>
OUT <sub>C</sub> [	6	11	] IN <sub>E</sub>
IN <sub>C</sub> [	7	10	] OUT <sub>D</sub>
V <sub>SS</sub> [	8	9	] IN <sub>D</sub>

#### MARKING DIAGRAMS

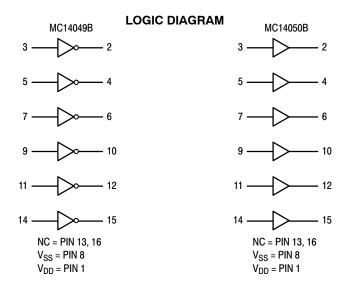


VVL, L	
YY, Y	= Year
WW, W	= Work Week
G or ∎	= Pb-Free Indicator
Noto: Mioro	dot may be in either location

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.



#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC14049BDG	SOIC-16 (Pb-Free)	48 Units / Rail
MC14049BDR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
NLV14049BDR2G*	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel

MC14050BDG	SOIC-16 (Pb-Free)	48 Units / Rail
MC14050BDR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
NLV14050BDR2G*	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
MC14050BDTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable.

<b>ELECTRICAL CHARACTERISTICS</b>	(Voltages Referenced to V <sub>SS</sub> )
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				–55°C +25°C			+12	+125°C			
Characterist	ic	Symbol	V <sub>DD</sub> Vdc	Min	Max	Min	Typ (Note 2)	Max	Min	Max	Unit
Output Voltage V <sub>in</sub> = V <sub>DD</sub>	"0" Level	V <sub>OL</sub>	5.0 10 15	- - -	0.05 0.05 0.05		0 0 0	0.05 0.05 0.05	- - -	0.05 0.05 0.05	Vdc
V <sub>in</sub> = 0	"1" Level	V <sub>OH</sub>	5.0 10 15	4.95 9.95 14.95	- - -	4.95 9.95 14.95	5.0 10 15	- - -	4.95 9.95 14.95		Vdc
Input Voltage $(V_O = 4.5 \text{ Vdc})$ $(V_O = 9.0 \text{ Vdc})$ $(V_O = 13.5 \text{ Vdc})$	"0" Level	V <sub>IL</sub>	5.0 10 15	- - -	1.5 3.0 4.0	_ _ _	2.25 4.50 6.75	1.5 3.0 4.0	- - -	1.5 3.0 4.0	Vdc
$(V_{O} = 0.5 \text{ Vdc})$ $(V_{O} = 1.0 \text{ Vdc})$ $(V_{O} = 1.5 \text{ Vdc})$	"1" Level	V <sub>IH</sub>	5.0 10 15	3.5 7.0 11		3.5 7.0 11	2.75 5.50 8.25		3.5 7.0 11		Vdc
$\begin{array}{l} \text{Output Drive Current} \\ (\text{V}_{\text{OH}} = 2.5 \ \text{Vdc}) \\ (\text{V}_{\text{OH}} = 9.5 \ \text{Vdc}) \\ (\text{V}_{\text{OH}} = 13.5 \ \text{Vdc}) \end{array}$	Source	I <sub>ОН</sub>	5.0 10 15	-1.6 -1.6 -4.7	- - -	-1.25 -1.30 -3.75	2.5 2.6 10	- - -	-1.0 -1.0 -3.0		mAdc
(V <sub>OL</sub> = 0.4 Vdc) (V <sub>OL</sub> = 0.5 Vdc) (V <sub>OL</sub> = 1.5 Vdc)	Sink	I <sub>OL</sub>	5.0 10 15	3.75 10 30	- - -	3.2 8.0 24	6.0 16 40	- - -	2.6 6.6 19	_ _ _	mAdc
Input Current		l <sub>in</sub>	15	-	±0.1	-	±0.00001	±0.1	-	±1.0	μAdc
Input Capacitance (V <sub>in</sub> =	: 0)	C <sub>in</sub>	-	-	-	-	10	20	-	-	pF
Quiescent Current (Per	Package)	I <sub>DD</sub>	5.0 10 15	- - -	1.0 2.0 4.0		0.002 0.004 0.006	1.0 2.0 4.0	- -	30 60 120	μAdc
Total Supply Current (No (Dynamic plus Quies per package) (C <sub>L</sub> = 50 pF on all ou buffers switching	cent,	ŀτ	5.0 10 15		-	I <sub>T</sub> = (3	1.8 μΑ/kHz) f 3.5 μΑ/kHz) f 5.3 μΑ/kHz) f	+ I <sub>DD</sub>	-	-	μAdc

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

The formulas given are for the typical characteristics only at +25°C
To calculate total supply current at loads other than 50 pF:

 $I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$ 

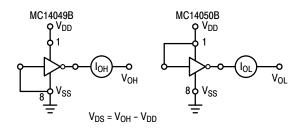
Where:  $I_T$  is in  $\mu A$  (per Package),  $C_L$  in pF,  $V = (V_{DD} - V_{SS})$  in volts, f in kHz is input frequency and k = 0.002.

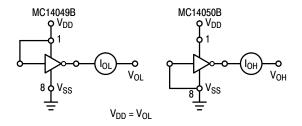
#### AC SWITCHING CHARACTERISTICS (Note 5) ( $C_L = 50 \text{ pF}$ , $T_A = +25^{\circ}C$ )

Characteristic	Symbol	V <sub>DD</sub> Vdc	Min	<b>Typ</b> (Note 6)	Мах	Unit
Output Rise Time $t_{TLH} = (0.7 \text{ ns/pF}) C_L + 65 \text{ ns}$ $t_{TLH} = (0.25 \text{ ns/pF}) C_L + 37.5 \text{ ns}$ $t_{TLH} = (0.2 \text{ ns/pF}) C_L + 30 \text{ ns}$	t <sub>тін</sub>	5.0 10 15	- - -	100 50 40	160 80 60	ns
Output Fall Time $t_{THL} = (0.2 \text{ ns/pF}) C_L + 30 \text{ ns}$ $t_{THL} = (0.06 \text{ ns/pF}) C_L + 17 \text{ ns}$ $t_{THL} = (0.04 \text{ ns/pF}) C_L + 13 \text{ ns}$	t <sub>THL</sub>	5.0 10 15	- - -	40 20 15	60 40 30	ns
$\begin{array}{l} Propagation \ Delay \ Time \\ t_{PLH} = (0.33 \ ns/pF) \ C_L + 63.5 \ ns \\ t_{PLH} = (0.19 \ ns/pF) \ C_L + 30.5 \ ns \\ t_{PLH} = (0.06 \ ns/pF) \ C_L + 27 \ ns \end{array}$	t <sub>PLH</sub>	5.0 10 15	- - -	80 40 30	140 80 60	ns
Propagation Delay Time $t_{PHL} = (0.2 \text{ ns/pF}) C_L + 30 \text{ ns}$ $t_{PHL} = (0.1 \text{ ns/pF}) C_L + 15 \text{ ns}$ $t_{PHL} = (0.05 \text{ ns/pF}) C_L + 12.5 \text{ ns}$	t₽HL	5.0 10 15	- - -	40 20 15	80 40 30	ns

5. The formulas given are for the typical characteristics only at 25°C.

6. Data labeled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.





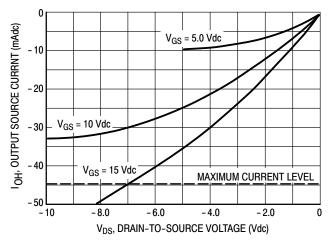


Figure 1. Typical Output Source Characteristics

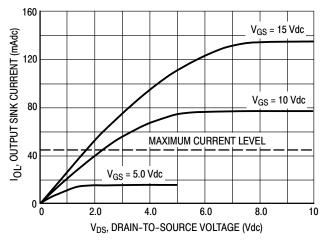


Figure 2. Typical Output Sink Characteristics

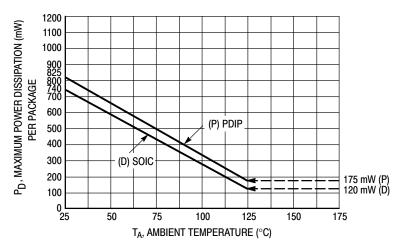


Figure 3. Ambient Temperature Power Derating

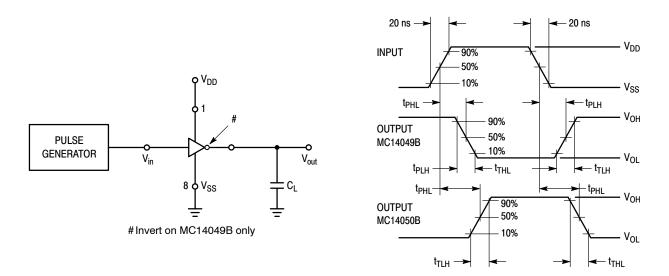


Figure 4. Switching Time Test Circuit and Waveforms

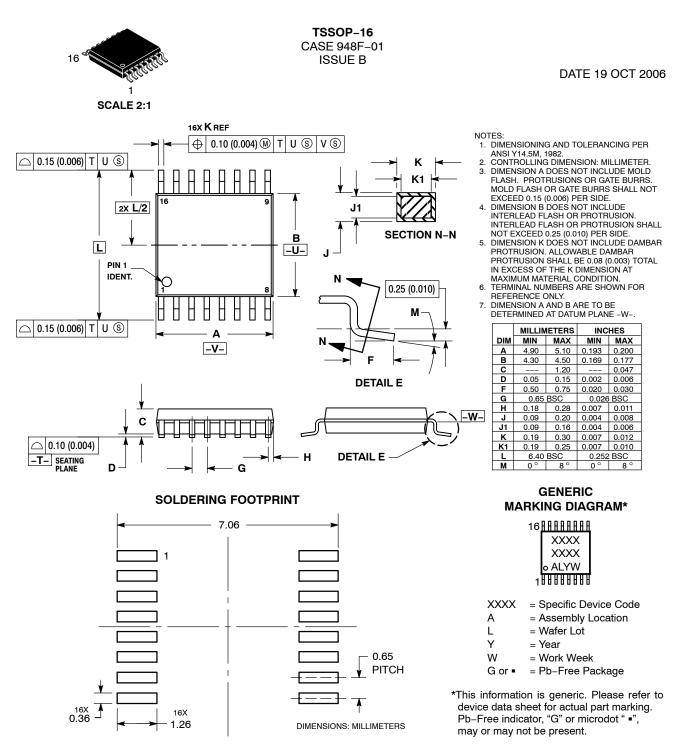




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